Components marked 'DNP' should not be populated.

Assembly Variant: 001

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<th>PCB Viewed From Top Side</th>
<th>Board #: PMP20545</th>
<th>Rev: A</th>
<th>Sun Rev: Not In Version Control</th>
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Plot Name = Top Assembly Drawing

Generated: 12/7/2016 5:24:45 PM

Texas Instruments
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<td>PLOT NAME = Bottom Assembly Drawing</td>
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<td>TEXAS INSTRUMENTS</td>
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